

# ICMAP 2018

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**Dr. Chi Hwan Lee** is an Assistant Professor at Purdue University, with joint appointments in the Departments of Biomedical Engineering & Mechanical Engineering. He serves as a Primary Faculty Member in the Center for Implantable Bioelectronics, the Center for Scalable Manufacturing, and the Birck Nanotechnology Center at Purdue University where his main research focus lies on developing mechanically flexible and stretchable wearable biomedical systems. He obtained a Ph.D. degree in Mechanical Engineering from Stanford University in 2013, and received a B.S. degree in Mechanical Engineering from Illinois Institute of Technology in 2007. He is the recipient of 2018 Hanwha Advanced Materials Non-tenured Faculty Award, 2017 Purdue Faculty Award of Excellence, and 2013 Top Innovation Award from the Technology Connect World National Innovation Summit.